

#### 150V PNP SMALL SIGNAL TRANSISTOR IN SOT23

#### **Features**

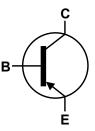
- Epitaxial Planar Die Construction
- Complementary NPN Type MMBT5551
- Ideal for Low Power Amplification and Switching
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

#### **Mechanical Data**

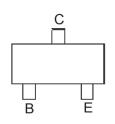
- Case: SOT23
- Case material: molded plastic, "Green" molding compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208
- Weight: 0.008 grams (Approximate)







Device Symbol



Top View Pin-Out

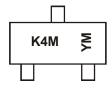
#### Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
MMBT5401-7-F	AEC-Q101	K4M	7	8	3,000
MMBT5401-13-F	AEC-Q101	K4M	13	8	10,000
MMBT5401Q-7-F	Automotive	K4M	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_compliance\_definitions/.
- $5.\ For\ packaging\ details,\ go\ to\ our\ website\ at\ http://www.diodes.com/products/packages.html.$

## **Marking Information**



K4M = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	J	K	L	М	N	Р	R	S	T	U	V	W	Х	Υ	Z	Α	В	С
Month	Jar	1	Feb	Ма	r	Apr	May	/	Jun	Jul		Aug	Sep		Oct	Nov		Dec



#### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-160	V
Collector-Emitter Voltage	$V_{CEO}$	-150	V
Emitter-Base Voltage	$V_{EBO}$	-5.0	V
Collector Current	I <sub>C</sub>	-600	mA

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 6)	D	310	mW
Power Dissipation	(Note 7)	P <sub>D</sub>	350	IIIVV
Thermal Resistance, Junction to Ambient	(Note 6)	В	403	°C/W
Thermal Resistance, Junction to Ambient	(Note 7)	$R_{\theta JA}$	357	-0/٧٧
Thermal Resistance, Junction to Leads (Note 8)		R <sub>0</sub> JL	350	°C/W
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C

### ESD Ratings (Note 9)

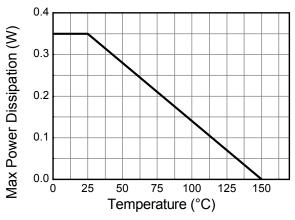
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 6. For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR4 PCB; device is measured under still air 7. Same as note (6), except the device is mounted on 15 mm x 15mm 1oz copper.
  8. Thermal resistance from junction to solder-point (at the end of the leads).
  9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



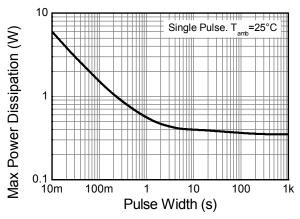
#### **Thermal Characteristics and Derating Information**



400 350 300 250 200 150 D=0.5 100 D=0.2 Single Pulse D=0.05 100μ 1m 10m 100m 1 10 100 1k Pulse Width (s)

**Derating Curve** 

**Transient Thermal Impedance** 



**Pulse Power Dissipation** 



### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 10)					
Collector-Base Breakdown Voltage	$BV_{CBO}$	-160	_	V	$I_C = -100\mu A$ , $I_E = 0$
Collector-Emitter Breakdown Voltage	$BV_{CEO}$	-150	_	V	$I_C = -1.0 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-5.0	_	V	$I_E = -10\mu A, I_C = 0$
Collector Cutoff Current	Ісво		-50 -50	nA	$V_{CB} = -120V, I_{E} = 0$
	ICBO			μΑ	$V_{CB} = -120V$ , $I_E = 0$ , $T_A = +100$ °C
Emitter Cutoff Current	I <sub>EBO</sub>	_	-50	nA	$V_{EB} = -4.0V, I_{C} = 0$
ON CHARACTERISTICS (Note 10)					_
		50	_		$I_C = -1.0 \text{mA}, V_{CE} = -5.0 \text{V}$
DC Current Gain	h <sub>FE</sub>	60	240	_	$I_C = -10 \text{mA}, V_{CE} = -5.0 \text{V}$
		50	_		$I_C = -50 \text{mA}, V_{CE} = -5.0 \text{V}$
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>		-0.2 -0.5	V	$I_C = -10 \text{mA}, I_B = -1.0 \text{mA}$
Collector-Emitter Saturation Voltage					$I_C = -50 \text{mA}, I_B = -5.0 \text{mA}$
Base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>		-1.0	V	$I_C = -10 \text{mA}, I_B = -1.0 \text{mA}$
Dase-Efficier Saturation Voltage		_	-1.0		$I_C = -50 \text{mA}, I_B = -5.0 \text{mA}$
SMALL SIGNAL CHARACTERISTICS					_
Output Capacitance	C <sub>obo</sub>	_	6.0	pF	$V_{CB} = -10V$ , $f = 1.0MHz$ , $I_E = 0$
Small Signal Current Gain	h <sub>fe</sub>	40	200	_	$V_{CE} = -10V, I_{C} = -1.0mA,$
Official Carrott Cam	rite	10	200		f = 1.0kHz
Current Gain-Bandwidth Product	f <sub>T</sub>	100	300	MHz	$V_{CE} = -10V, I_{C} = -10mA,$ f = 100MHz
Noise Figure	NF	_	8.0	dB	$V_{CE} = -5.0V$ , $I_{C} = -200\mu A$ , $R_{S} = 10\Omega$ , $f = 1.0kHz$

Notes: 10. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.



# **Typical Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

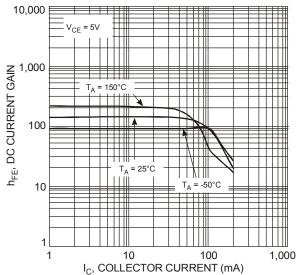
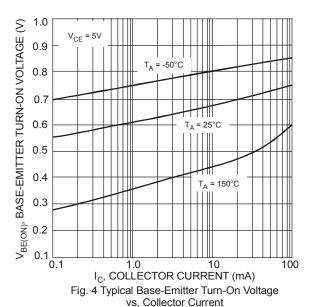


Fig. 2 Typical DC Current Gain vs. Collector Current



10.0 | T<sub>A</sub> = 150°C | T<sub>A</sub> = -50°C |

Fig. 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current

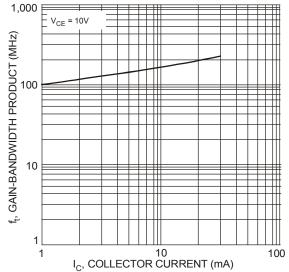
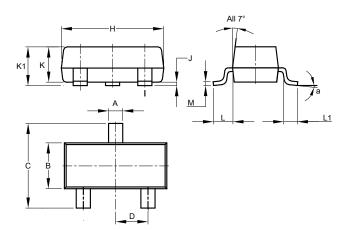


Fig. 5 Typical Gain-Bandwidth Product vs. Collector Current



# **Package Outline Dimensions**

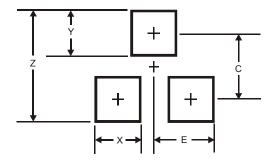
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SOT23								
Dim	Min	Max	Тур						
Α	0.37	0.51	0.40						
В	1.20	1.40	1.30						
С	2.30	2.50	2.40						
D	0.89	1.03	0.915						
F	0.45	0.60	0.535						
G	1.78	2.05	1.83						
Н	2.80	3.00	2.90						
J	0.013	0.10	0.05						
K	0.890	1.00	0.975						
K1	0.903	1.10	1.025						
L	0.45	0.61	0.55						
L1	0.25	0.55	0.40						
М	0.085	0.150	0.110						
а		8°							
All	Dimens	ions in	mm						

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
С	2.0
Е	1.35

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.



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